

INTERNATIONAL JOURNAL OF HEAT AND MASS TRANSFER

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The *International Journal of Heat and Mass Transfer* seeks to provide a central vehicle for exchange of basic ideas in heat and/or mass transfer between research workers and engineers located throughout the world. Only those papers that convey original unpublished research of permanent interest—analytical, numerical and/or experimental—and featuring explicitly heat and/or mass transfer, will be accepted for publication. In all cases, the highest priority will be given to those contributions which increase our basic understanding of transfer processes and of their application to engineering problems.

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Technical notes may also be submitted. In some cases, an alternate route for a much faster publication of a technical note or a short paper may be the *International Communications in Heat and Mass Transfer* journal. This companion journal, published by Elsevier Inc. with the same Board of Editors, serves as a world forum for the rapid dissemination of new ideas, new measurement techniques, preliminary findings of ongoing investigations, discussions, and criticisms in the field of heat and mass transfer.

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